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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I²C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	59
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2136csdfp-30

1.1.2 Specifications

Tables 1.1 and 1.2 outline Specifications.

Table 1.1 Specifications (1)

Item	Function	Description
CPU	Central processing unit	R8C CPU core • Number of fundamental instructions: 89 • Minimum instruction execution time: 50 ns (CPU clock = 20 MHz, VCC = 2.7 V to 5.5 V) 200 ns (CPU clock = 5 MHz, VCC = 1.8 V to 5.5 V) • Multiplier: 16 bits × 16 bits → 32 bits • Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits • Operating mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM, data flash	Refer to **Table 1.3 Product List**.
Voltage detection	Voltage detection circuit	• Power-on reset • Voltage detection with three check points (the detection levels for voltage detection 0 and voltage detection 1 can be selected.)
I/O ports	Programmable I/O ports	• Input only: 1 • CMOS I/O: 59, selectable pull-up resistor • High current drive ports: 59
Clock	Clock generation circuits	• 4 circuits: XIN clock oscillation circuit, XCIN clock oscillation circuit, high-speed on-chip oscillator (with frequency adjustment function), low-speed on-chip oscillator • Oscillation stop detection: XIN clock oscillation stop detection function • Frequency divider circuit: Divided by 1, 2, 4, 8, or 16 can be selected • Low-power mode: Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		• Number of interrupt vectors: 69 • External interrupt inputs: 9 (INT × 5, key input × 4) • Priority levels: 7
Event link controller (ELC)		• Events output from peripheral functions can be linked to events input to different peripheral functions. (30 sources × 10 types of event link operations) • Events can be handled independently from interrupt requests.
Watchdog timer		• 14 bits × 1 • Selectable reset start function • Selectable low-speed on-chip oscillator for the watchdog timer
DTC (data transfer controller)		• 1 channel • Activation sources: 27 • Transfer modes: 2 (normal mode, repeat mode)
Timer	Timers RJ_0	16 bits × 1: 1 circuit integrated on-chip Timer mode (periodic timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB2_0	16 bits × 1: 1 circuit integrated on-chip Timer mode (periodic timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timers RC_0	16 bits (with 4 capture/compare registers) × 1: 1 circuit integrated on-chip Timer mode (input capture function, output compare function), PWM mode (output: 3 pins), PWM2 mode (PWM output: 1 pin)
	Timer RE2	8 bits × 1 Compare match timer mode, real-time clock mode

1.3 Block Diagram

Figure 1.2 shows the Block Diagram.

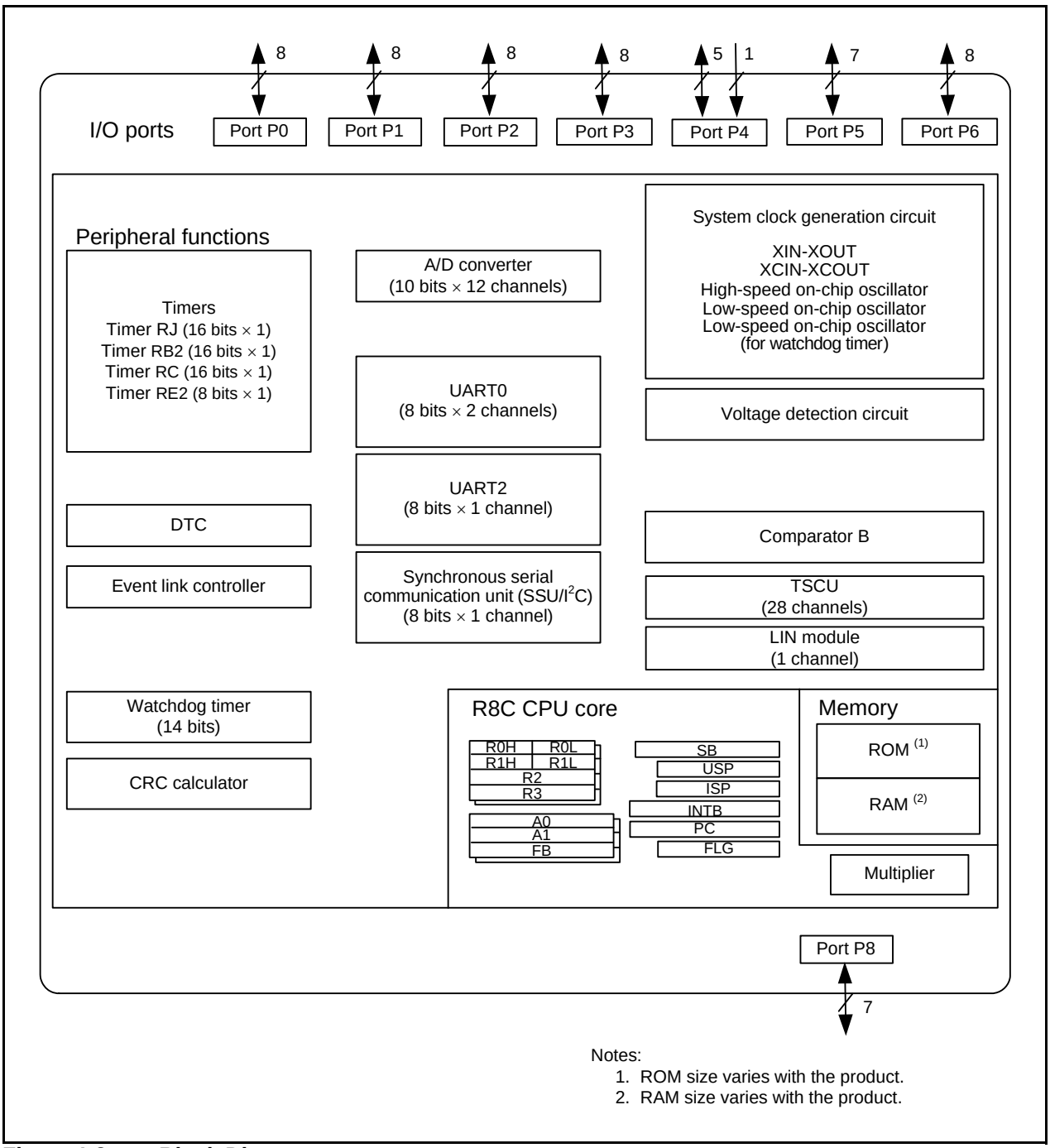


Figure 1.2 Block Diagram

Table 1.4 Pin Name Information by Pin Number (INT, URAT0, and UART2)

Port	Pin No.	INT					UART0						UART2						
		$\overline{INT0}$	$\overline{INT1}$	$\overline{INT2}$	$\overline{INT3}$	$\overline{INT4}$	TXD_0	TXD_1	RXD_0	RXD_1	CLK_0	CLK_1	TXD2	RXD2	$\overline{CTS2}$	$\overline{RTS2}$	SDA2	SCL2	CLK2
P0_0	56																		
P0_1	55							TXD_1											
P0_2	54									RXD_1									
P0_3	53											CLK_1							
P0_4	52																		
P0_5	51																		
P0_6	50																		
P0_7	49																		
P1_0	48																		
P1_1	47																		
P1_2	46																		
P1_3	45																		
P1_4	44						TXD_0												
P1_5	43		$\overline{INT1}$						RXD_0										
P1_6	42										CLK_0								
P1_7	41		$\overline{INT1}$																
P2_0	27		$\overline{INT1}$																
P2_1	26																		
P2_2	25																		
P2_3	24																		
P2_4	23																		
P2_5	22																		
P2_6	21																		
P2_7	20																		
P3_0	1																		
P3_1	29																		
P3_2	64		$\overline{INT1}$	$\overline{INT2}$															
P3_3	19				$\overline{INT3}$										$\overline{CTS2}$	$\overline{RTS2}$			
P3_4	18												TXD2	RXD2			SDA2	SCL2	
P3_5	17																		CLK2
P3_6	28																		
P3_7	16												TXD2	RXD2			SDA2	SCL2	
P4_2	2																		
P4_3	4																		
P4_4	5																		
P4_5	40	$\overline{INT0}$												RXD2				SCL2	
P4_6	9																		
P4_7	7																		
P5_0	15																		
P5_1	14																		
P5_2	13																		
P5_3	12																		
P5_4	11																		
P5_6	63																		
P5_7	62																		
P6_0	61																		
P6_1	60																		
P6_2	59											CLK_1							
P6_3	58							TXD_1											
P6_4	57									RXD_1									
P6_5	39					$\overline{INT4}$						CLK_1							CLK2
P6_6	38			$\overline{INT2}$									TXD2				SDA2		
P6_7	37				$\overline{INT3}$														
P8_0	36																		
P8_1	35																		
P8_2	34																		
P8_3	33																		
P8_4	32																		
P8_5	31																		
P8_6	30																		

Table 1.6 Pin Name Information by Pin Number (Timer RC, Timer RE2, and Others)

Port	Pin No.	Timer RC						Timer RE2	Others		
		TRCCLK_0	TRCIOA_0	TRCIOB_0	TRCIOC_0	TRCIOD_0	TRCTRG_0	TMRE2O			
P0_0	56		TRCIOA_0				TRCTRG_0		AN7		
P0_1	55		TRCIOA_0				TRCTRG_0		AN6		
P0_2	54		TRCIOA_0				TRCTRG_0		AN5		
P0_3	53			TRCIOB_0					AN4		
P0_4	52			TRCIOB_0				TMRE2O	AN3		
P0_5	51			TRCIOB_0					AN2		
P0_6	50					TRCIOD_0			AN1		
P0_7	49				TRCIOC_0				AN0		
P1_0	48					TRCIOD_0			AN8	$\overline{KI0}$	
P1_1	47		TRCIOA_0				TRCTRG_0		AN9	$\overline{KI1}$	
P1_2	46			TRCIOB_0					AN10	$\overline{KI2}$	
P1_3	45				TRCIOC_0				AN11	$\overline{KI3}$	
P1_4	44	TRCCLK_0									
P1_5	43										
P1_6	42								IVREF1		CH00
P1_7	41								IVCMP1		CH01
P2_0	27			TRCIOB_0							CH16
P2_1	26				TRCIOC_0						CH17
P2_2	25					TRCIOD_0					CH18
P2_3	24										CH19
P2_4	23										CH20
P2_5	22										CH21
P2_6	21										CH22
P2_7	20										CH23
P3_0	1										CH24
P3_1	29										CH10
P3_2	64										CH25
P3_3	19	TRCCLK_0							IVCMP3		
P3_4	18				TRCIOC_0				IVREF3		
P3_5	17					TRCIOD_0					
P3_6	28										CH11
P3_7	16										
P4_2	2								VREF		
P4_3	4								XCIN		
P4_4	5								XCOUT		
P4_5	40								$\overline{ADTRG}$		CH02
P4_6	9								XIN		
P4_7	7								XOUT		
P5_0	15	TRCCLK_0									
P5_1	14		TRCIOA_0				TRCTRG_0				
P5_2	13			TRCIOB_0							
P5_3	12				TRCIOC_0						
P5_4	11					TRCIOD_0					
P5_6	63										CH27
P5_7	62										CH28
P6_0	61							TMRE2O			CH31
P6_1	60										CH32
P6_2	59										CH33
P6_3	58										CH34
P6_4	57										CH35
P6_5	39			TRCIOB_0							CH03
P6_6	38				TRCIOC_0						CH04
P6_7	37					TRCIOD_0					CH05
P8_0	36										CH06
P8_1	35										CH07
P8_2	34										CHxA0
P8_3	33										CHxA1
P8_4	32										CHxB
P8_5	31										CHxC
P8_6	30										CH08

1.5 Pin Functions

Tables 1.7 and 1.8 list Pin Functions.

Table 1.7 Pin Functions (1)

Item	Pin Name	I/O	Description
Power supply input	VCC, VSS	—	Apply 1.8 V through 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply input for the A/D converter. Connect a capacitor between pins AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Applying a low level to this pin resets the MCU.
MODE	MODE	I	Connect this pin to the VCC pin via a resistor.
XIN clock input	XIN	I	I/O for the XIN clock generation circuit. Connect a ceramic resonator or a crystal oscillator between pins XIN and XOUT. (1) To use an external clock, input it to the XIN pin and leave the XOUT pin open.
XIN clock output	XOUT	I/O	
XCIN clock input	XCIN	I	I/O for the XCIN clock generation circuit. Connect a crystal oscillator between pins XCIN and XCOUT. (1) To use an external clock, input it to the XCOUT pin and leave the XCIN pin open.
XCIN clock output	XCOUT	I/O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT4}}$	I	$\overline{\text{INT}}$ interrupt input.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI3}}$	I	Key input interrupt input.
Timer RJ_0	TRJIO_0	I/O	Input/output for timer RJ.
	TRJO_0	O	Output for timer RJ.
Timer RB2_0	TRBO_0	O	Output for timer RB2.
Timer RC_0	TRCCLK_0	I	External clock input.
	TRCTRG_0	I	External trigger input.
	TRCIOA_0, TRCIOB_0, TRCIOC_0, TRCIOD_0	I/O	Input/output for timer RC.
Timer RE2	TMRE2O	O	Divided clock output.
Serial interface (UART0)	CLK_0, CLK_1	I/O	Transfer clock input/output.
	RXD_0, RXD_1	I	Serial data input.
	TXD_0, TXD_1	O	Serial data output.
Serial interface (UART2)	$\overline{\text{CTS2}}$	I	Input for transmission control.
	$\overline{\text{RTS2}}$	O	Output for reception control.
	SCL2	I/O	I^2C mode clock input/output.
	SDA2	I/O	I^2C mode data input/output.
	RXD2	I	Serial data input.
	TXD2	O	Serial data output.
	CLK2	I/O	Transfer clock input/output.
Synchronous serial communication unit (SSU_0)	SSI_0	I/O	Data input/output.
	$\overline{\text{SCS\_0}}$	I/O	Chip-select input/output.
	$\overline{\text{SSCK\_0}}$	I/O	Clock input/output.
	SSO_0	I/O	Data input/output.
I^2C bus (I^2C_0)	SCL_0	I/O	Clock input/output.
	SDA_0	I/O	Data input/output.
Reference voltage input	VREF	I	Reference voltage input for the A/D converter.

Note:
1. Contact the oscillator manufacturer for oscillation characteristics.

Table 3.2 SFR Information (2) (1)

Address	Symbol	Register Name	After Reset	Remarks
0003Ah	VW2C	Voltage Monitor 2 Circuit Control Register	10001010b	
0003Bh				
0003Ch				
0003Dh				
0003Eh				
0003Fh				
00040h				
00041h	FMRDYIC	Interrupt Control Register	00h	
00042h				
00043h				
00044h				
00045h				
00046h	INT4IC	Interrupt Control Register	00h	
00047h	TRCIC_0	Interrupt Control Register	00h	
00048h				
00049h				
0004Ah	TRE2IC	Interrupt Control Register	00h	
0004Bh	U2TIC	Interrupt Control Register	00h	
0004Ch	U2RIC	Interrupt Control Register	00h	
0004Dh	KUPIC	Interrupt Control Register	00h	
0004Eh	ADIC	Interrupt Control Register	00h	
0004Fh	SSUIC_0/IICIC_0	Interrupt Control Register	00h	
00050h				
00051h	U0TIC_0	Interrupt Control Register	00h	
00052h	U0RIC_0	Interrupt Control Register	00h	
00053h	U0TIC_1	Interrupt Control Register	00h	
00054h	U0RIC_1	Interrupt Control Register	00h	
00055h	INT2IC	Interrupt Control Register	00h	
00056h	TRJIC_0	Interrupt Control Register	00h	
00057h				
00058h	TRB2IC_0	Interrupt Control Register	00h	
00059h	INT1IC	Interrupt Control Register	00h	
0005Ah	INT3IC	Interrupt Control Register	00h	
0005Bh				
0005Ch				
0005Dh	INT0IC	Interrupt Control Register	00h	
0005Eh	U2BCNIC	Interrupt Control Register	00h	
0005Fh				
00060h				
00061h				
00062h				
00063h				
00064h				
00065h				
00066h				
00067h				
00068h				
00069h				
0006Ah				
0006Bh				
0006Ch				
0006Dh				
0006Eh				
0006Fh				
00070h				
00071h				
00072h	VCMP1IC	Interrupt Control Register	00h	
00073h	VCMP2IC	Interrupt Control Register	00h	
00074h				
00075h	TSCUIC	Interrupt Control Register	00h	
00076h				
00077h				
00078h				
00079h				

Note:
1. The blank areas are reserved. No access is allowed.

Table 3.8 SFR Information (8) (1)

Address	Symbol	Register Name	After Reset	Remarks
0023Ah	MSTCR2	Module Standby Control Register 2	00h	
0023Bh	MSTCR3	Module Standby Control Register 3	00h	
0023Ch	MSTCR4	Module Standby Control Register 4	00h	
0023Dh				
0023Eh				
0023Fh				
00240h				
00241h				
00242h				
00243h				
00244h				
00245h				
00246h				
00247h				
00248h				
00249h				
0024Ah				
0024Bh				
0024Ch				
0024Dh				
0024Eh				
0024Fh				
00250h				
00251h				
00252h	FST	Flash Memory Status Register	10000X00b	
00253h				
00254h	FMR0	Flash Memory Control Register 0	00h	
00255h	FMR1	Flash Memory Control Register 1	00h	
00256h	FMR2	Flash Memory Control Register 2	00h	
00257h				
00258h				
00259h				
0025Ah				
0025Bh				
0025Ch				
0025Dh				
0025Eh				
0025Fh				
00260h	AIADR0L	Address Match Interrupt Address 0L Register	XXXXh	
00261h				
00262h	AIADR0H	Address Match Interrupt Address 0H Register	0000XXXXb	
00263h	AIEN0	Address Match Interrupt Enable 0 Register	00h	
00264h	AIADR1L	Address Match Interrupt Address 1L Register	XXXXh	
00265h				
00266h	AIADR1H	Address Match Interrupt Address 1H Register	0000XXXXb	
00267h	AIEN1	Address Match Interrupt Enable 1 Register	00h	
00268h				
00269h				
0026Ah				
0026Bh				
0026Ch				
0026Dh				
0026Eh				
0026Fh				
00270h				
00271h				
00272h				
00273h				
00274h				
00275h				
00276h				
00277h				
00278h				
00279h				
0027Ah				
0027Bh				
0027Ch				
0027Dh				
0027Eh				
0027Fh				

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.10 SFR Information (10) (1)

Address	Symbol	Register Name	After Reset	Remarks
002C0h	PUR0	Pull-Up Control Register 0	00h	
002C1h	PUR1	Pull-Up Control Register 1	00h	
002C2h	PUR2	Pull-Up Control Register 2	00h	
002C3h				
002C4h				
002C5h				
002C6h				
002C7h				
002C8h	P1DRR	Port P1 Drive Capacity Control Register	00h	
002C9h	P2DRR	Port P2 Drive Capacity Control Register	00h	
002CAh				
002CBh				
002CCh	DRR0	Drive Capacity Control Register 0	00h	
002CDh	DRR1	Drive Capacity Control Register 1	00h	
002CEh	DRR2	Drive Capacity Control Register 2	00h	
002CFh				
002D0h	VLT0	Input Threshold Control Register 0	00h	
002D1h	VLT1	Input Threshold Control Register 1	00h	
002D2h	VLT2	Input Threshold Control Register 2	00h	
002D3h				
002D4h				
002D5h				
002D6h				
002D7h				
002D8h				
002D9h				
002DAh				
002DBh				
002DCh				
002DDh				
002DEh				
002DFh				
002E0h	PORT0	Port P0 Register	XXh	
002E1h	PORT1	Port P1 Register	XXh	
002E2h	PD0	Port P0 Direction Register	00h	
002E3h	PD1	Port P1 Direction Register	00h	
002E4h	PORT2	Port P2 Register	XXh	
002E5h	PORT3	Port P3 Register	XXh	
002E6h	PD2	Port P2 Direction Register	00h	
002E7h	PD3	Port P3 Direction Register	00h	
002E8h	PORT4	Port P4 Register	XXh	
002E9h	PORT5	Port P5 Register	XXh	
002EAh	PD4	Port P4 Direction Register	00h	
002EBh	PD5	Port P5 Direction Register	00h	
002ECh	PORT6	Port P6 Register	XXh	
002EDh				
002EEh	PD6	Port P6 Direction Register	00h	
002EFh				
002F0h	PORT8	Port P8 Register	XXh	
002F1h				
002F2h	PD8	Port P8 Direction Register	00h	
002F3h				
002F4h				
002F5h				
002F6h				
002F7h				
002F8h				
002F9h				
002FAh				
002FBh				
002FCh				
002FDh				
002FEh				
002FFh				
00300h to 003FFh				

Note:
1. The blank areas are reserved. No access is allowed.

Table 3.11 SFR Information (11) (1)

Address	Symbol	Register Name	After Reset	Remarks
00400h to 053FFh	On-chip RAM	On-chip RAM		
05400h to 069FFh				
06A00h	ELSELR0	Event Output Destination Select Register 0	00h	
06A01h	ELSELR1	Event Output Destination Select Register 1	00h	
06A02h	ELSELR2	Event Output Destination Select Register 2	00h	
06A03h	ELSELR3	Event Output Destination Select Register 3	00h	
06A04h	ELSELR4	Event Output Destination Select Register 4	00h	
06A05h				
06A06h				
06A07h				
06A08h	ELSELR8	Event Output Destination Select Register 8	00h	
06A09h	ELSELR9	Event Output Destination Select Register 9	00h	
06A0Ah				
06A0Bh	ELSELR11	Event Output Destination Select Register 11	00h	
06A0Ch	ELSELR12	Event Output Destination Select Register 12	00h	
06A0Dh	ELSELR13	Event Output Destination Select Register 13	00h	
06A0Eh	ELSELR14	Event Output Destination Select Register 14	00h	
06A0Fh	ELSELR15	Event Output Destination Select Register 15	00h	
06A10h	ELSELR16	Event Output Destination Select Register 16	00h	
06A11h				
06A12h				
06A13h				
06A14h				
06A15h				
06A16h				
06A17h				
06A18h				
06A19h				
06A1Ah				
06A1Bh				
06A1Ch				
06A1Dh				
06A1Eh				
06A1Fh				
06A20h				
06A21h				
06A22h				
06A23h				
06A24h				
06A25h				
06A26h				
06A27h				
06A28h				
06A29h				
06A2Ah				
06A2Bh				
06A2Ch				
06A2Dh				
06A2Eh				
06A2Fh				
06A30h				
06A31h to 06AFFh				

Note:
1. The blank areas are reserved. No access is allowed.

Table 3.13 SFR Information (13) (1)

Address	Symbol	Register Name	After Reset	Remarks
06C0Ah		Area for storing DTC transfer vector 10	XXh	
06C0Bh		Area for storing DTC transfer vector 11	XXh	
06C0Ch		Area for storing DTC transfer vector 12	XXh	
06C0Dh		Area for storing DTC transfer vector 13	XXh	
06C0Eh		Area for storing DTC transfer vector 14	XXh	
06C0Fh		Area for storing DTC transfer vector 15	XXh	
06C10h		Area for storing DTC transfer vector 16	XXh	
06C11h		Area for storing DTC transfer vector 17	XXh	
06C12h		Area for storing DTC transfer vector 18	XXh	
06C13h		Area for storing DTC transfer vector 19	XXh	
06C14h				
06C15h				
06C16h		Area for storing DTC transfer vector 22	XXh	
06C17h		Area for storing DTC transfer vector 23	XXh	
06C18h		Area for storing DTC transfer vector 24	XXh	
06C19h		Area for storing DTC transfer vector 25	XXh	
06C1Ah				
06C1Bh				
06C1Ch				
06C1Dh				
06C1Eh				
06C1Fh				
06C20h				
06C21h				
06C22h				
06C23h				
06C24h				
06C25h				
06C26h				
06C27h				
06C28h				
06C29h				
06C2Ah		Area for storing DTC transfer vector 42	XXh	
06C2Bh				
06C2Ch				
06C2Dh				
06C2Eh				
06C2Fh				
06C30h				
06C31h		Area for storing DTC transfer vector 49	XXh	
06C32h				
06C33h		Area for storing DTC transfer vector 51	XXh	
06C34h		Area for storing DTC transfer vector 52	XXh	
06C35h		Area for storing DTC transfer vector 53	XXh	
06C36h		Area for storing DTC transfer vector 54	XXh	
06C37h				
06C38h				
06C39h				
06C3Ah				
06C3Bh				
06C3Ch				
06C3Dh				
06C3Eh				
06C3Fh				
06C40h	DTCCR0	DTC Control Register 0	XXh	
06C41h	DTBLS0	DTC Block Size Register 0	XXh	
06C42h	DTCCT0	DTC Transfer Count Register 0	XXh	
06C43h	DTRLD0	DTC Transfer Count Reload Register 0	XXh	
06C44h	DTSAR0	DTC Source Address Register 0	XXXXh	
06C45h				
06C46h	DTDAR0	DTC Destination Address Register 0	XXXXh	
06C47h				
06C48h	DTCCR1	DTC Control Register 1	XXh	
06C49h	DTBLS1	DTC Block Size Register 1	XXh	

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.14 SFR Information (14) (1)

Address	Symbol	Register Name	After Reset	Remarks
06C4Ah	DTCCT1	DTC Transfer Count Register 1	XXh	
06C4Bh	DTRLD1	DTC Transfer Count Reload Register 1	XXh	
06C4Ch	DTSAR1	DTC Source Address Register 1	XXXXh	
06C4Dh				
06C4Eh	DTDAR1	DTC Destination Address Register 1	XXXXh	
06C4Fh				
06C50h	DTCCR2	DTC Control Register 2	XXh	
06C51h	DTBLS2	DTC Block Size Register 2	XXh	
06C52h	DTCCT2	DTC Transfer Count Register 2	XXh	
06C53h	DTRLD2	DTC Transfer Count Reload Register 2	XXh	
06C54h	DTSAR2	DTC Source Address Register 2	XXXXh	
06C55h				
06C56h	DTDAR2	DTC Destination Address Register 2	XXXXh	
06C57h				
06C58h	DTCCR3	DTC Control Register 3	XXh	
06C59h	DTBLS3	DTC Block Size Register 3	XXh	
06C5Ah	DTCCT3	DTC Transfer Count Register 3	XXh	
06C5Bh	DTRLD3	DTC Transfer Count Reload Register 3	XXh	
06C5Ch	DTSAR3	DTC Source Address Register 3	XXXXh	
06C5Dh				
06C5Eh	DTDAR3	DTC Destination Address Register 3	XXXXh	
06C5Fh				
06C60h	DTCCR4	DTC Control Register 4	XXh	
06C61h	DTBLS4	DTC Block Size Register 4	XXh	
06C62h	DTCCT4	DTC Transfer Count Register 4	XXh	
06C63h	DTRLD4	DTC Transfer Count Reload Register 4	XXh	
06C64h	DTSAR4	DTC Source Address Register 4	XXXXh	
06C65h				
06C66h	DTDAR4	DTC Destination Address Register 4	XXXXh	
06C67h				
06C68h	DTCCR5	DTC Control Register 5	XXh	
06C69h	DTBLS5	DTC Block Size Register 5	XXh	
06C6Ah	DTCCT5	DTC Transfer Count Register 5	XXh	
06C6Bh	DTRLD5	DTC Transfer Count Reload Register 5	XXh	
06C6Ch	DTSAR5	DTC Source Address Register 5	XXXXh	
06C6Dh				
06C6Eh	DTDAR5	DTC Destination Address Register 5	XXXXh	
06C6Fh				
06C70h	DTCCR6	DTC Control Register 6	XXh	
06C71h	DTBLS6	DTC Block Size Register 6	XXh	
06C72h	DTCCT6	DTC Transfer Count Register 6	XXh	
06C73h	DTRLD6	DTC Transfer Count Reload Register 6	XXh	
06C74h	DTSAR6	DTC Source Address Register 6	XXXXh	
06C75h				
06C76h	DTDAR6	DTC Destination Address Register 6	XXXXh	
06C77h				
06C78h	DTCCR7	DTC Control Register 7	XXh	
06C79h	DTBLS7	DTC Block Size Register 7	XXh	
06C7Ah	DTCCT7	DTC Transfer Count Register 7	XXh	
06C7Bh	DTRLD7	DTC Transfer Count Reload Register 7	XXh	
06C7Ch	DTSAR7	DTC Source Address Register 7	XXXXh	
06C7Dh				
06C7Eh	DTDAR7	DTC Destination Address Register 7	XXXXh	
06C7Fh				
06C80h	DTCCR8	DTC Control Register 8	XXh	
06C81h	DTBLS8	DTC Block Size Register 8	XXh	
06C82h	DTCCT8	DTC Transfer Count Register 8	XXh	
06C83h	DTRLD8	DTC Transfer Count Reload Register 8	XXh	
06C84h	DTSAR8	DTC Source Address Register 8	XXXXh	
06C85h				
06C86h	DTDAR8	DTC Destination Address Register 8	XXXXh	
06C87h				
06C88h	DTCCR9	DTC Control Register 9	XXh	
06C89h	DTBLS9	DTC Block Size Register 9	XXh	
06C8Ah	DTCCT9	DTC Transfer Count Register 9	XXh	
06C8Bh	DTRLD9	DTC Transfer Count Reload Register 9	XXh	
06C8Ch	DTSAR9	DTC Source Address Register 9	XXXXh	
06C8Dh				
06C8Eh	DTDAR9	DTC Destination Address Register 9	XXXXh	
06C8Fh				

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

Table 3.15 SFR Information (15) (1)

Address	Symbol	Register Name	After Reset	Remarks
06C90h	DTCCR10	DTC Control Register 10	XXh	
06C91h	DTBLS10	DTC Block Size Register 10	XXh	
06C92h	DTCCT10	DTC Transfer Count Register 10	XXh	
06C93h	DTRLD10	DTC Transfer Count Reload Register 10	XXh	
06C94h	DTSAR10	DTC Source Address Register 10	XXXXh	
06C95h				
06C96h	DTDAR10	DTC Destination Address Register 10	XXXXh	
06C97h				
06C98h	DTCCR11	DTC Control Register 11	XXh	
06C99h	DTBLS11	DTC Block Size Register 11	XXh	
06C9Ah	DTCCT11	DTC Transfer Count Register 11	XXh	
06C9Bh	DTRLD11	DTC Transfer Count Reload Register 11	XXh	
06C9Ch	DTSAR11	DTC Source Address Register 11	XXXXh	
06C9Dh				
06C9Eh	DTDAR11	DTC Destination Address Register 11	XXXXh	
06C9Fh				
06CA0h	DTCCR12	DTC Control Register 12	XXh	
06CA1h	DTBLS12	DTC Block Size Register 12	XXh	
06CA2h	DTCCT12	DTC Transfer Count Register 12	XXh	
06CA3h	DTRLD12	DTC Transfer Count Reload Register 12	XXh	
06CA4h	DTSAR12	DTC Source Address Register 12	XXXXh	
06CA5h				
06CA6h	DTDAR12	DTC Destination Address Register 12	XXXXh	
06CA7h				
06CA8h	DTCCR13	DTC Control Register 13	XXh	
06CA9h	DTBLS13	DTC Block Size Register 13	XXh	
06CAAh	DTCCT13	DTC Transfer Count Register 13	XXh	
06CABh	DTRLD13	DTC Transfer Count Reload Register 13	XXh	
06CACh	DTSAR13	DTC Source Address Register 13	XXXXh	
06CADh				
06CAEh	DTDAR13	DTC Destination Address Register 13	XXXXh	
06CAFh				
06CB0h	DTCCR14	DTC Control Register 14	XXh	
06CB1h	DTBLS14	DTC Block Size Register 14	XXh	
06CB2h	DTCCT14	DTC Transfer Count Register 14	XXh	
06CB3h	DTRLD14	DTC Transfer Count Reload Register 14	XXh	
06CB4h	DTSAR14	DTC Source Address Register 14	XXXXh	
06CB5h				
06CB6h	DTDAR14	DTC Destination Address Register 14	XXXXh	
06CB7h				
06CB8h	DTCCR15	DTC Control Register 15	XXh	
06CB9h	DTBLS15	DTC Block Size Register 15	XXh	
06CBAh	DTCCT15	DTC Transfer Count Register 15	XXh	
06CBBh	DTRLD15	DTC Transfer Count Reload Register 15	XXh	
06CBCh	DTSAR15	DTC Source Address Register 15	XXXXh	
06CBDh				
06CBEh	DTDAR15	DTC Destination Address Register 15	XXXXh	
06CBFh				
06CC0h	DTCCR16	DTC Control Register 16	XXh	
06CC1h	DTBLS16	DTC Block Size Register 16	XXh	
06CC2h	DTCCT16	DTC Transfer Count Register 16	XXh	
06CC3h	DTRLD16	DTC Transfer Count Reload Register 16	XXh	
06CC4h	DTSAR16	DTC Source Address Register 16	XXXXh	
06CC5h				
06CC6h	DTDAR16	DTC Destination Address Register 16	XXXXh	
06CC7h				
06CC8h	DTCCR17	DTC Control Register 17	XXh	
06CC9h	DTBLS17	DTC Block Size Register 17	XXh	
06CCAh	DTCCT17	DTC Transfer Count Register 17	XXh	
06CCBh	DTRLD17	DTC Transfer Count Reload Register 17	XXh	
06CCCh	DTSAR17	DTC Source Address Register 17	XXXXh	
06CCDh				
06CCEh	DTDAR17	DTC Destination Address Register 17	XXXXh	
06CCFh				

X: Undefined

Note:

1. The blank areas are reserved. No access is allowed.

4. Electrical Characteristics

4.1 Absolute Maximum Ratings

Table 4.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc ICEVcc	Supply voltage		–0.3 to 6.5	V
V_I	Input voltage		–0.3 to Vcc + 0.3	V
V_O	Output voltage		–0.3 to Vcc + 0.3	V
P_d	Power dissipation	–40°C ≤ Topr ≤ 85°C	500	mW
T_{opr}	Operating ambient temperature		–20 to 85 (N version)/ –40 to 85 (D version)	°C
T_{stg}	Storage temperature		–65 to 150	°C

Table 4.5 Flash Memory (Program ROM) Characteristics (Vcc = 2.7 V to 5.5 V, Topr = –20°C to 85°C (N version)/–40°C to 85°C (D version), unless otherwise specified)

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
—	Program/erase endurance (1)		1,000 (2)	—	—	times
—	Byte program time (Program and erase endurance ≤ 100 times)		—	—	—	µs
—	Byte program time (Program and erase endurance ≤ 1,000 times)		—	—	—	µs
—	Word program time (Program and erase endurance ≤ 100 times)	Topr = 25°C, Vcc = 5.0 V	—	100	200	µs
—	Word program time (Program and erase endurance ≤ 100 times)		—	100	400	µs
—	Word program time (Program and erase endurance ≤ 1,000 times)		—	100	650	µs
—	Block erase time		—	0.3	4	s
$t_{d(SR-SUS)}$	Time delay from suspend request until suspend		—	—	5 + CPU clock × 3 cycles	ms
—	Interval from erase start/restart until following suspend request		0	—	—	µs
—	Time from suspend until erase restart		—	—	30 + CPU clock × 1 cycle	µs
$t_{d(CMDRST-READY)}$	Time from when command is forcibly terminated until reading is enabled		—	—	30 + CPU clock × 1 cycle	µs
—	Program, erase voltage		2.7	—	5.5	V
—	Read voltage		1.8	—	5.5	V
—	Program, erase temperature		–20 (N ver.) –40 (D ver.)	—	85	°C
—	Data hold time (6)	Ambient temperature = 55°C (7)	20	—	—	year

Notes:
1. Definition of programming/erasure endurance
   The programming and erasure endurance is defined on a per-block basis.
   If the programming and erasure endurance is n (n = 100 or 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.
   However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
2. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
3. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
4. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
5. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
6. The data hold time includes time that the power supply is off or the clock is not supplied.
7. The data hold time includes 7,000 hours under an environment of ambient temperature 85°C.

Table 4.6 Flash Memory (Data flash Block A to Block D) Characteristics (Vcc = 2.7 V to 5.5 V, Topr = –20°C to 85°C (N version)/–40°C to 85°C (D version), unless otherwise specified)

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
—	Program/erase endurance (1)		10,000 (2)	—	—	times
—	Byte program time (Program and erase endurance ≤ 1,000 times)		—	160	950	µs
—	Byte program time (Program and erase endurance > 1,000 times)		—	300	950	µs
—	Block erase time (Program and erase endurance ≤ 1,000 times)		—	0.2	1	s
—	Block erase time (Program and erase endurance > 1,000 times)		—	0.3	1	s
$t_{d(SR-SUS)}$	Time delay from suspend request until suspend		—	—	3 + CPU clock × 3 cycles	ms
—	Interval from erase start/restart until following suspend request		0	—	—	µs
—	Time from suspend until erase restart		—	—	30 + CPU clock × 1 cycle	µs
$t_{d(CMDRST-READY)}$	Time from when command is forcibly terminated until reading is enabled		—	—	30 + CPU clock × 1 cycle	µs
—	Program, erase voltage		2.7	—	5.5	V
—	Read voltage		1.8	—	5.5	V
—	Program, erase temperature		–20 (N ver.) –40 (D ver.)	—	85	°C
—	Data hold time (6)	Ambient temperature = 55°C (7)	20	—	—	year

Notes:
1. Definition of programming/erasure endurance
   The programming and erasure endurance is defined on a per-block basis.
   If the programming and erasure endurance is n (n = 100, 1,000 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.
   However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
2. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
3. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A to D can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
4. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
5. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
6. The data hold time includes time that the power supply is off or the clock is not supplied.
7. The data hold time includes 7,000 hours under an environment of ambient temperature 85°C.

Table 4.12 Low-Speed On-Chip Oscillator Circuit Characteristics (Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/ –40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
fLOCO	Low-speed on-chip oscillator frequency		60	125	250	kHz
—	Oscillation stability time	Vcc = 5.0 V, Topr = 25°C	—	30	100	µs
—	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	—	3	—	µA

Table 4.13 Power Supply Circuit Characteristics (Measurement conditions: Vcc = 1.8 V to 5.5 V, Topr = –20°C to 85°C (N version)/ –40°C to 85°C (D version))

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
$t_{d(P-R)}$	Time for internal power supply stabilization during power-on (1)		—	—	2,000	µs

Note:
1. Waiting time until the internal power supply generation circuit stabilizes during power-on.

Table 4.17 DC Characteristics (4) [2.7 V ≤ Vcc < 3.3 V] (Topr = –20°C to 85°C (N version)/–40°C to 85°C (D version), unless otherwise specified))

Symbol	Parameter	Conditions								Standard (4)			Unit
			Oscillation		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other	Min.	Typ.	Max.	
			XIN (2)	XCIN	High-Speed	Low-Speed							
Icc	Power supply current (1)	High-speed clock mode	10 MHz	Off	Off	125 kHz	No division	—		—	3.5	10	mA
			10 MHz	Off	Off	125 kHz	Divide-by-8	—		—	1.5	7.5	mA
		High-speed on-chip oscillator mode	Off	Off	20 MHz (3)	125 kHz	No division	—		—	7.0	15	mA
			Off	Off	20 MHz (3)	125 kHz	Divide-by-8	—		—	3.0	—	mA
			Off	Off	10 MHz (3)	125 kHz	No division	—		—	4.0	—	mA
			Off	Off	10 MHz (3)	125 kHz	Divide-by-8	—		—	1.5	—	mA
			Off	Off	4 MHz (3)	125 kHz	Divide-by-16	MSTIIC = 1 MSTTRC = 1		—	1	—	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 SVC0 = 0		—	90	390	µA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 SVC0 = 0		—	80	400	µA
			Off	32 kHz	Off	Off	No division	FMSTP = 1 SVC0 = 0	Program operation on RAM Flash memory off	—	40	—	µA
		Wait mode	Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock operation	—	15	90	µA
			Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock off	—	4	80	µA
			Off	32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 SVC0 = 1	While a WAIT instruction is executed Peripheral clock off	—	3.5	—	µA
		Stop mode	Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25°C Peripheral clock off	—	2.2	6.0	µA
			Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85°C Peripheral clock off	—	30	—	µA

Notes:
1. Vcc = 2.7 V to 3.3 V, single-chip mode, output pins are open, and other pins are Vss.
2. XIN is set to square wave input.
3. fHOCO-F
4. The typical value (Typ.) indicates the current value when the CPU and the memory operate.
   The maximum value (Max.) indicates the current value when the CPU, the memory, and the peripheral functions operate and the flash memory is programmed/erased.

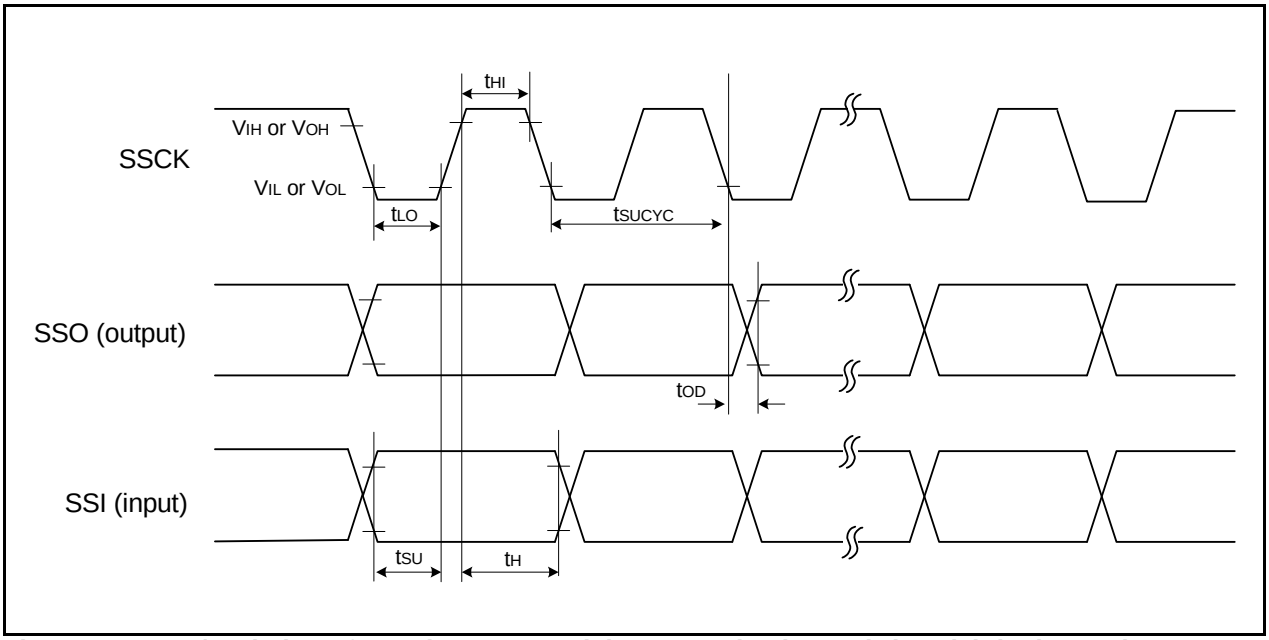
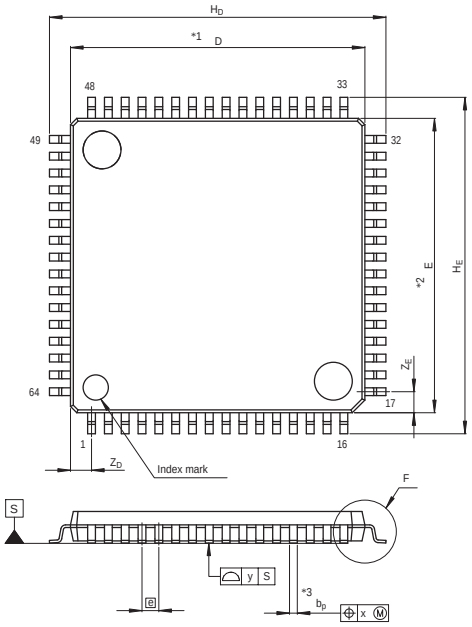
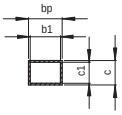


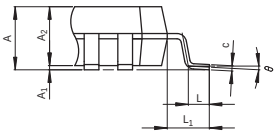
Figure 4.6 I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

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